

# DMG9926USD DUAL N-CHANNEL ENHANCEMENT MODE FIELD EFFECT TRANSISTOR

#### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> max	l <sub>D</sub> max T <sub>A</sub> = +25°C
	24mΩ @ V <sub>GS</sub> = 4.5V	8A
20V	29mΩ @ V <sub>GS</sub> = 2.5V	5.5A
	37mΩ @ V <sub>GS</sub> = 1.8V	4.8A

## Description

This MOSFET has been designed to minimize the on-state

resistance ( $R_{DS(on)}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

# Applications

- Power Management Functions
- DC-DC Converters
- •

#### Features

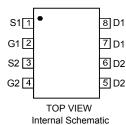
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

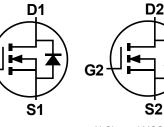
# **Mechanical Data**

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Copper lead frame. Solderable per MIL-STD-202, Method 208
- Weight: 0.072g (approximate)

**G1** 







N-Channel MOSFET

N-Channel MOSFET

## Ordering Information (Note 4)

Part Number	Case	Packaging
DMG9926USD-13	SO-8	2,500/Tape & Reel

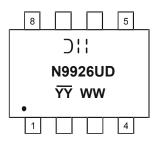
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

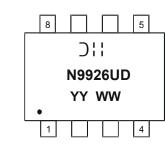
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**



Chengdu A/T Site



Shanghai A/T Site

)'' = Manufacturer's Marking
N9926UD = Product Type Marking Code
YYWW = Date Code Marking
YY or YY = Year (ex: 13 = 2013)
WW = Week (01 - 53)
YY = Date Code Marking for SAT (Shanghai Assembly/ Test site)
YY = Date Code Marking for CAT (Chengdu Assembly/ Test site)



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Char	acteristic		Symbol	Value	Units
Drain-Source Voltage			V <sub>DSS</sub>	20	V
Gate-Source Voltage			V <sub>GSS</sub>	±8	V
Drain Current (Note 5)	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	8 6.7	А
Pulsed Drain Current (Note 6)			I <sub>DM</sub>	30	A

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	PD	1.3	W
Thermal Resistance, Junction to Ambient	R <sub>0JA</sub>	96	°C/W
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	20	_		V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_		1	μA	$V_{DS} = 20V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	_	_	±100	nA	$V_{GS}$ = ±8V, $V_{DS}$ = 0V	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(th)</sub>	0.5		0.9	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
			19	24		V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 8.2A	
Static Drain-Source On-Resistance	R <sub>DS (ON)</sub>		23	29	mΩ	V <sub>GS</sub> = 2.5V, I <sub>D</sub> = 3.3A	
	. ,		29	37		V <sub>GS</sub> = 1.8V, I <sub>D</sub> = 2A	
Forward Transfer Admittance	Y <sub>fs</sub>	_	7	_	S	V <sub>DS</sub> = 10V, I <sub>D</sub> = 4A	
Diode Forward Voltage	V <sub>SD</sub>	0.5	_	0.9	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 1A	
DYNAMIC CHARACTERISTICS (Note 8)					_		
Input Capacitance	Ciss	_	867	_	pF	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V f = 1MHz	
Output Capacitance	Coss	_	85	_	pF		
Reverse Transfer Capacitance	Crss	_	81		pF		
Gate Resistance	RG		1.29		Ω	$V_{GS}$ = 0V, $V_{DS}$ = 0V, f = 1MHz	
SWITCHING CHARACTERISTICS (Note 8)					_		
Total Gate Charge	Qg	_	8.8		nC	V <sub>GS</sub> = 4.5V, V <sub>DS</sub> = 10V, I <sub>D</sub> = 8.2A	
Gate-Source Charge	Q <sub>gs</sub>	_	1.2		nC		
Gate-Drain Charge	Q <sub>qd</sub>		3		nC		
Turn-On Delay Time	t <sub>d(on)</sub>	_	13.2		ns	V <sub>DD</sub> = 10V, V <sub>GS</sub> = 4.5V, R <sub>L</sub> = 10Ω, R <sub>G</sub> = 6Ω	
Turn-On Rise Time	tr	_	12.6		ns		
Turn-Off Delay Time	t <sub>d(off)</sub>	_	64.8	—	ns		
Turn-Off Fall Time	t <sub>f</sub>	_	21.7		ns	7	

Notes:

5. Device mounted on FR-4 PCB with minimum recommended pad layout.

6. Repetitive rating, pulse width limited by function temperature.

7. Short duration pulse test used to minimize self-heating effect.

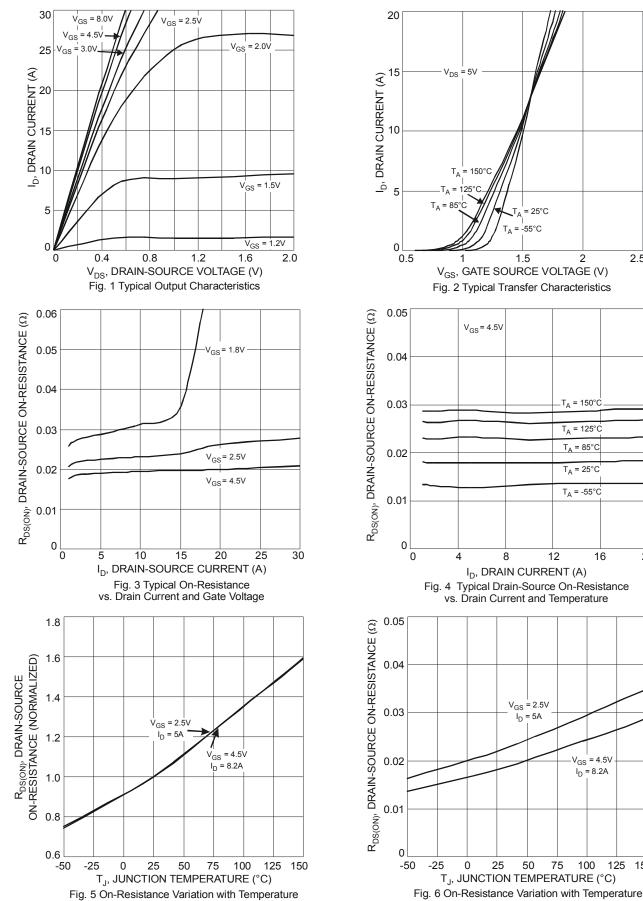
8. Guaranteed by design. Not subject to production testing.



# DMG9926USD

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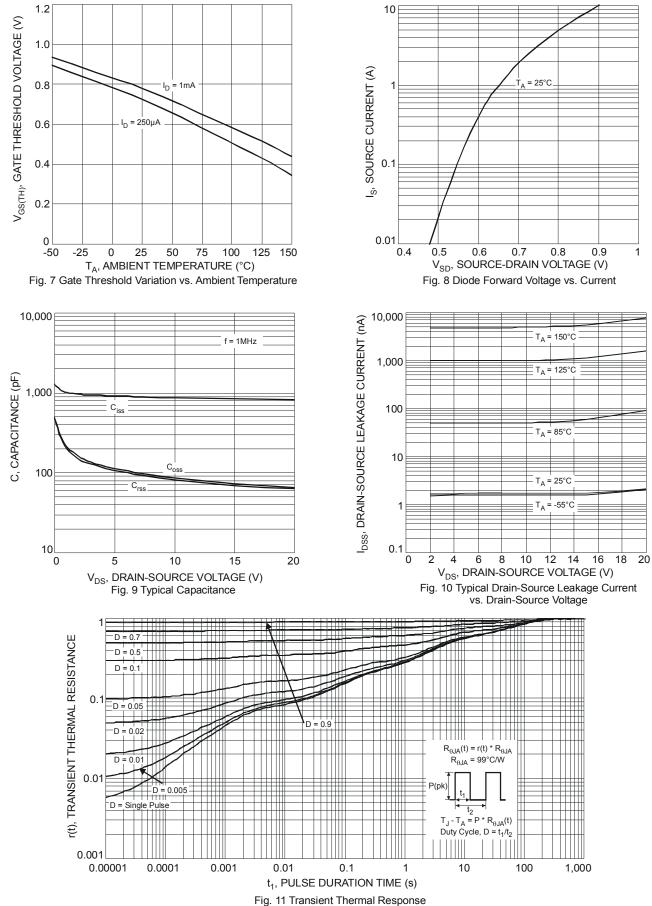


NEW PRODUCT

DMG9926USD Document number: DS31757 Rev. 5 - 2 150



# DMG9926USD



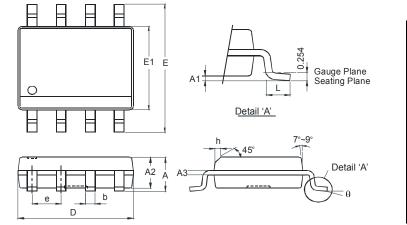
NEW PRODUCT

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# **Package Outline Dimensions**

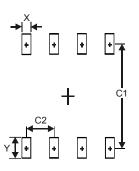
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOP-8L					
Dim	Min	Max			
Α	-	1.75			
A1	0.10	0.20			
A2	1.30	1.50			
A3	0.15	0.25			
b	0.3	0.5			
D	4.85	4.95			
ш	5.90	6.10			
E1	3.85	3.95			
e	1.27 Typ				
h	-	0.35			
L	0.62	0.82			
θ	0°	8°			
All Dimensions in mm					

# Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Х	0.60
Y	1.55
C1	5.4
C2	1.27



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